

Product Summary

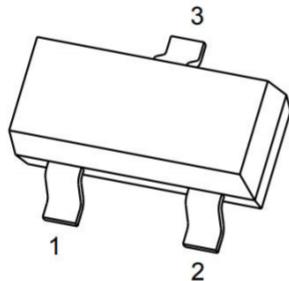
- V_{DS} 200 V
- I_{DS} ($V_{GS}=10V$) 1.0 A
- $R_{DS(ON)}$ ($V_{GS}=10V$) $\leq 1.7\Omega$ (Typ)

Application

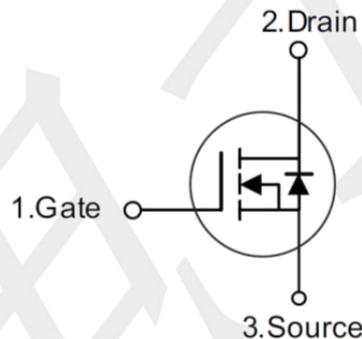
- Interfacing Switching
- DC-DC Converters
- Power management functions

Package and Pin Configuration

1. GATE
2. SOURCE
3. DRAIN



Circuit diagram



SOT23

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	200	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current $T_A=25^\circ C$	I_D	1.0	A
Continuous Drain Current $T_A=70^\circ C$	I_D	0.7	A
Pulsed Drain Current ($t = 100 \mu s$)	I_{DM}	4.0	A
Maximum Power Dissipation	P_D	1.0	W
		0.8	W
Operating Junction Temperature Range	T_J	-55 to +150	°C
Storage Temperature Range	T_{stg}	-55 to +150	°C

Thermal Characteristic

PARAMETER	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient($t \leq 10s$)	$R_{\theta JA}$	125	°C/W

Note : When mounted on 1" square PCB (FR4 material).

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Characteristics						
Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}, I_D= 250\mu\text{A}$	BV_{DSS}	200	--	--	V
Gate-Source Threshold Voltage	$V_{DS}=V_{GS}, I_D= 250\mu\text{A}$	$V_{GS(\text{th})}$	1.0	1.7	2.0	V
Gate-Source Leakage	$V_{DS}=0\text{V}, V_{GS}= \pm 20\text{V}$	I_{GSS}	--	--	± 100	nA
Zero Gate Voltage Drain Current	$V_{DS}= 200\text{V}, V_{GS}=0\text{V}$	I_{DSS}	--	--	1.0	μA
Drain-Source On-State Resistance (Note 1)	$V_{GS}= 10\text{V}, I_D=0.8\text{A}$	$R_{DS(\text{on})}$	--	1.7	2.0	Ω
	$V_{GS}= 5\text{V}, I_D= 0.5\text{A}$		--	1.9	2.4	
Forward Transconductance ^(Note 2)	$V_{DS}= 2\text{V}, I_D=1\text{A}$	g_{fs}	--	5	--	S
Dynamic ^(Note 2)						
Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, F= 1.0\text{MHz}$	C_{iss}	--	150	--	pF
Output Capacitance		C_{oss}	--	85	--	
Reverse Transfer Capacitance		C_{rss}	--	3.0	--	
Switching						
Turn-On Delay Time ^(Note 3)	$V_{DS} = 100\text{V}, V_{GS}= 10\text{V}, I_D = 1.0\text{A}, R_G = 1\Omega.$	$t_{d(on)}$	--	9.0	--	nS
Rise Time ^(Note 3)		t_r	--	12	--	
Turn-Off Delay Time ^(Note 3)		$t_{d(off)}$	--	14	--	
Fall Time ^(Note 3)		t_f	--	13	--	
Total Gate Charge	$V_{DS} = 100\text{V}, I_D= 1\text{A}, V_{GS}= 10\text{V}$	Q_g	--	5.6	--	nC
Gate Source Charge		Q_{gs}	--	0.8	--	
Gate Drain Charge		Q_{gd}	--	1.9	--	
Source-Drain Diode Ratings and Characteristics ^(Note 2)						
Forward Voltage	$V_{GS} = 0\text{V}, I_F = 0.1\text{A}$	V_{SD}	--	0.8	1.2	V
Continuous Source Current	Integral reverse diode in the MOSFET	I_S	--	--	1.0	A
Pulsed Current ^(Note 1)		I_{SM}	--	--	4.0	A

Notes:

1. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
2. Guaranteed by design, not subject to production testing.
3. Independent of operating temperature

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Figure 1. Output Characteristics

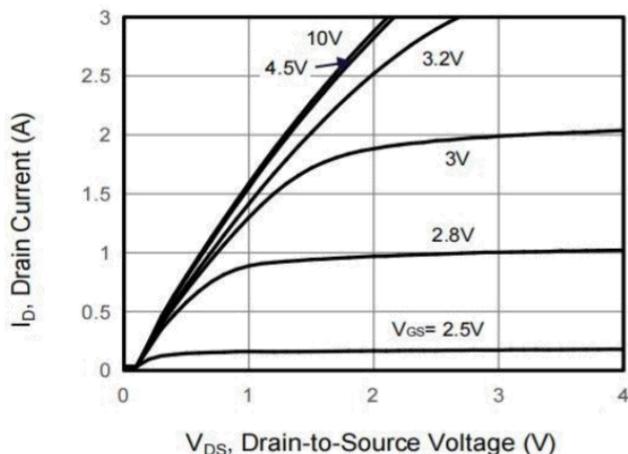


Figure 2. Transfer Characteristics

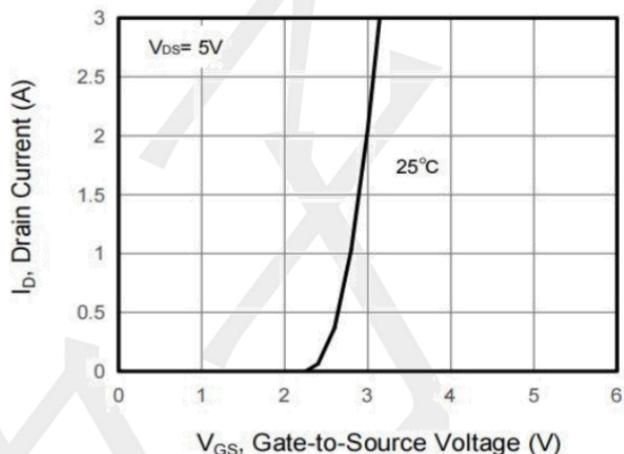


Figure 3. Drain Source On Resistance

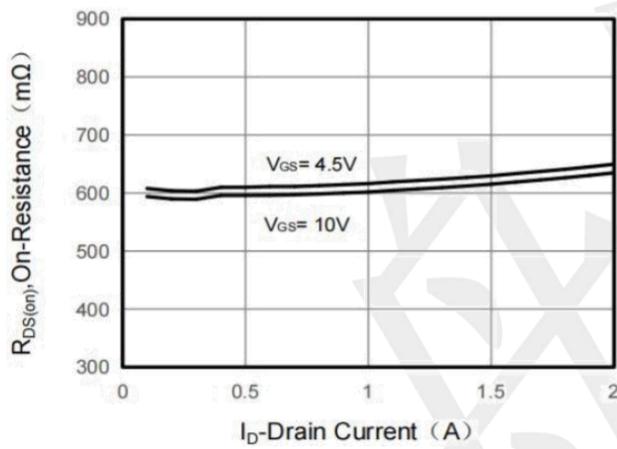


Figure 4. Gate Charge

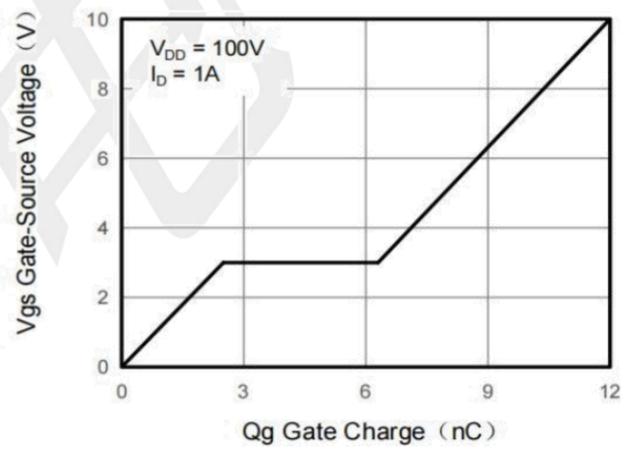


Figure 5. Capacitance

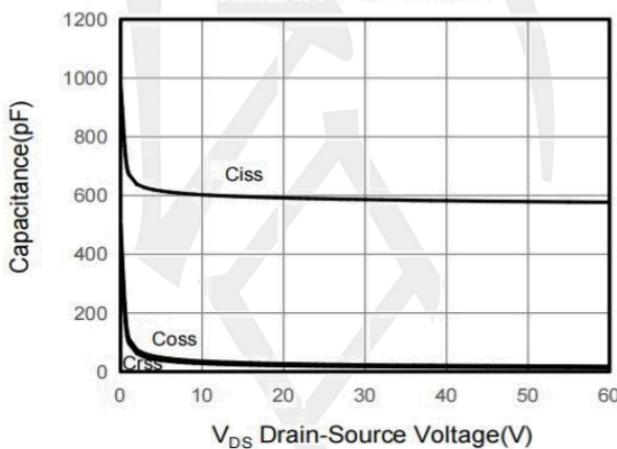
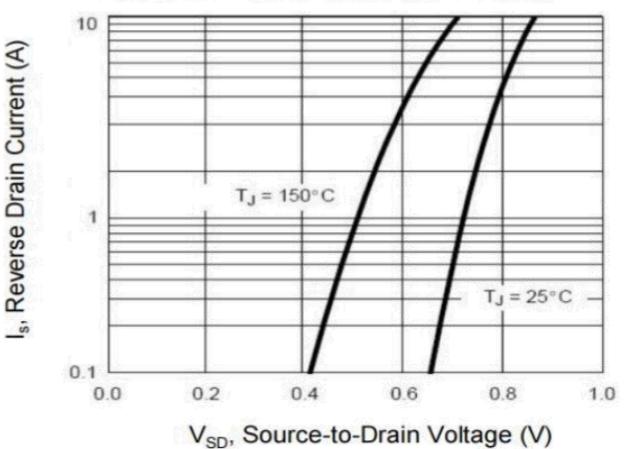
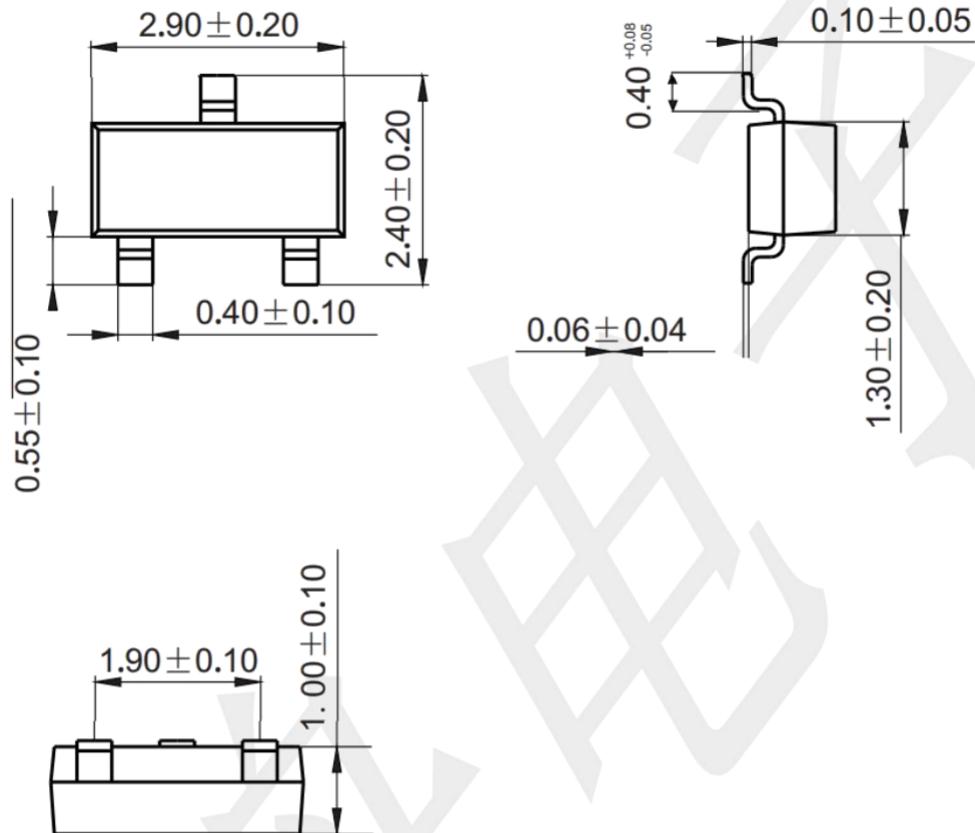


Figure 6. Source-Drain Diode Forward



Package Outline Dimensions (unit: mm)

SOT23



Mounting Pad Layout (unit: mm)

